

Power Schottky rectifier

Features

- very small conduction losses
- negligible switching losses
- extremely fast switching
- avalanche capability specified

Description

Dual center tap Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged either in TO-220AB, D²PAK, I²PAK, or DPAK, this device is especially intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.

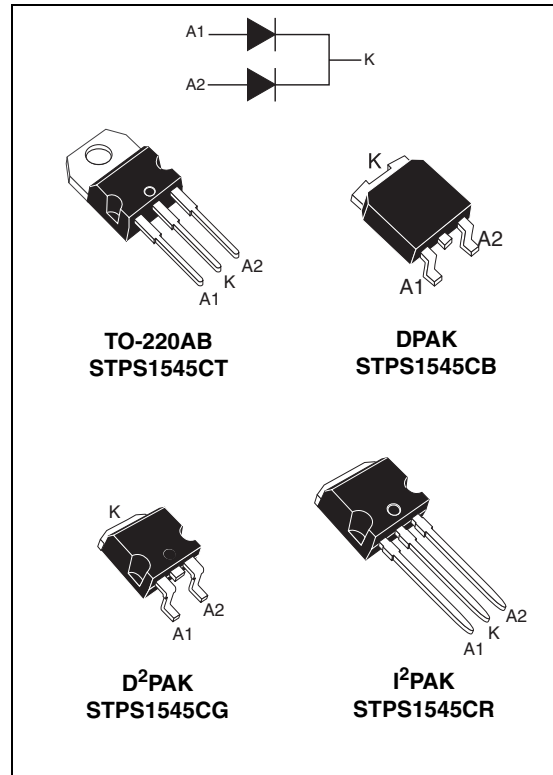


Table 1. Device summary

$I_{F(AV)}$	2 x 7.5 A
V_{RRM}	45 V
T_j (max)	175 °C
V_F (max)	0.57 V

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		45	V
I _{F(RMS)}	Forward rms current		20	A
I _{F(AV)}	Average forward current $\delta = 0.5$	T _c = 157 °C Per diode	7.5	A
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	150	A
I _{RRM}	Peak repetitive reverse current	t _p = 2 μ s square F = 1 kHz	1	A
I _{RSM}	Non repetitive peak reverse current	t _p = 100 μ s square	2	A
P _{ARM}	Repetitive peak avalanche power	t _p = 1 μ s T _j = 25 °C	2700	W
T _{stg}	Storage temperature range		-65 to + 175	°C
T _j	Maximum operating junction temperature ⁽¹⁾		175	°C
dV/dt	Critical rate of rise of reverse voltage		10000	V/ μ s

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistances

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case	Per diode Total	3.0 1.7	°C/W
R _{th(c)}	Coupling		0.35	

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_j(\text{diode 1}) = P(\text{diode1}) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode2}) \times R_{th(c)}$$

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-	-	100	μ A
		T _j = 125 °C		-	5	15	mA
V _F ⁽¹⁾	Forward voltage drop	T _j = 125°C	I _F = 7.5A	-	0.5	0.57	V
		T _j = 25°C	I _F = 15 A	-	-	0.84	
		T _j = 125 °C	I _F = 15 A	-	0.65	0.72	

1. Pulse test: t_p = 380 μ s, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.42 \times I_{F(AV)} + 0.020 I_{F(RMS)}^2$$

Figure 1. Average forward power dissipation versus average forward current (per diode)

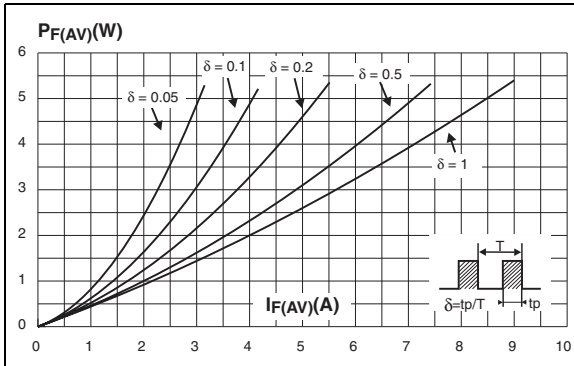


Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$, per diode)

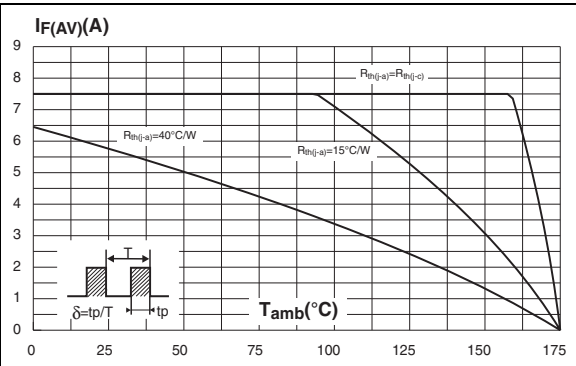


Figure 3. Normalized avalanche power derating versus pulse duration

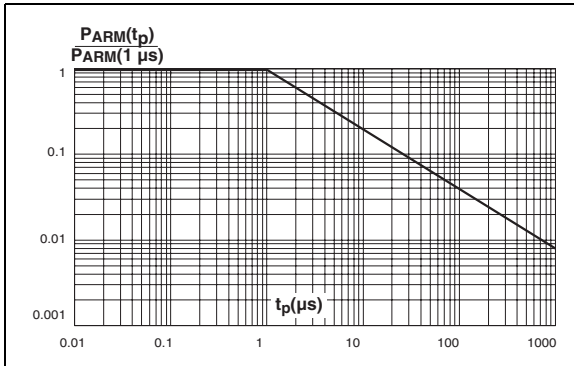


Figure 4. Normalized avalanche power derating versus junction temperature

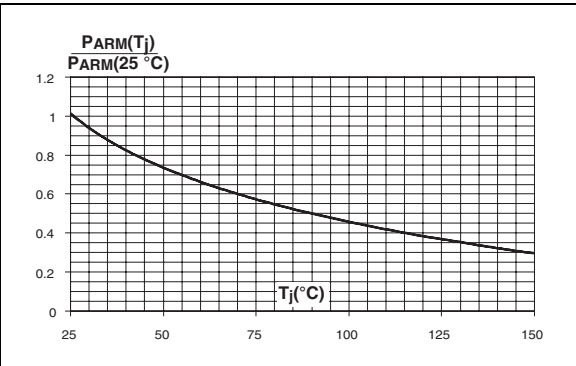


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values, per diode)

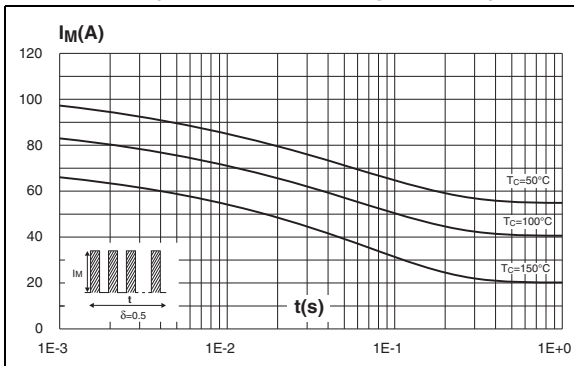


Figure 6. Relative variation of thermal impedance junction to case versus pulse duration

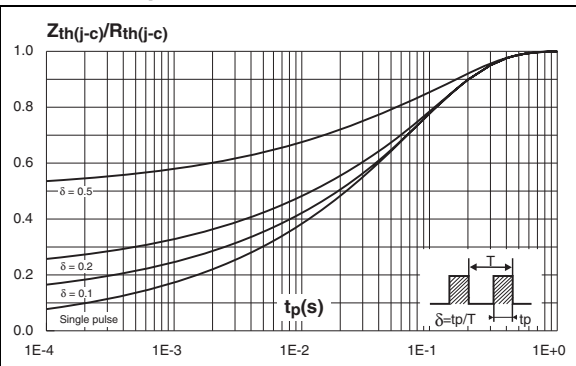


Figure 7. Reverse leakage current versus reverse voltage applied (typical values, per diode)

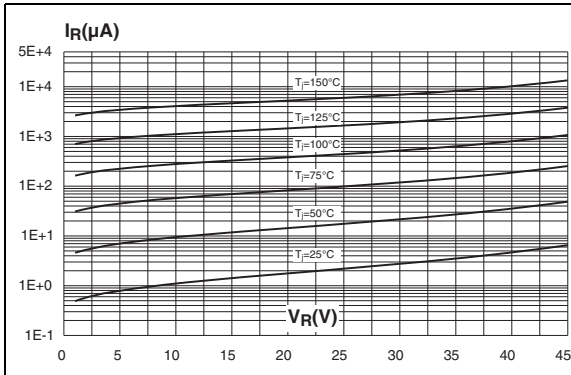


Figure 8. Junction capacitance versus reverse voltage applied (typical values, per diode)

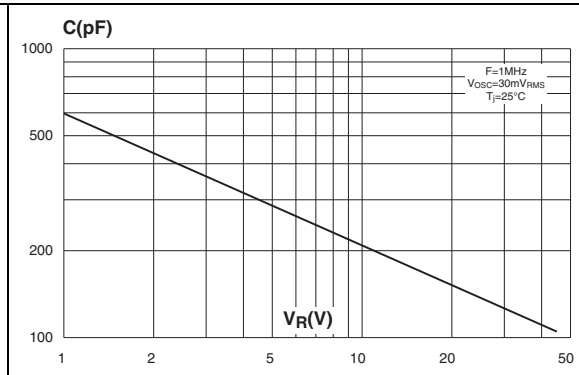


Figure 9. Forward voltage drop versus forward current (high values, per diode)

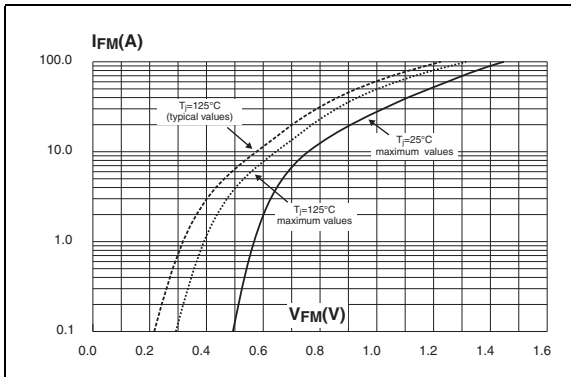


Figure 10. Thermal resistance junction to ambient versus copper surface under tab (D²PAK)

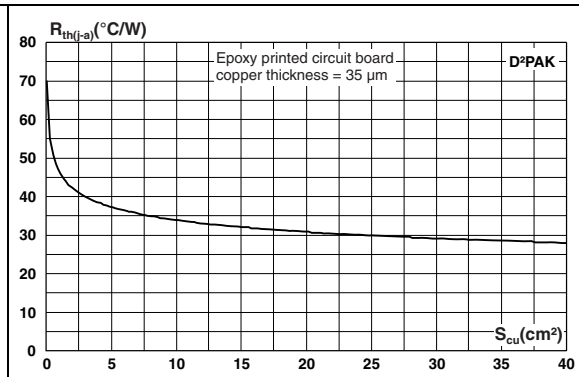
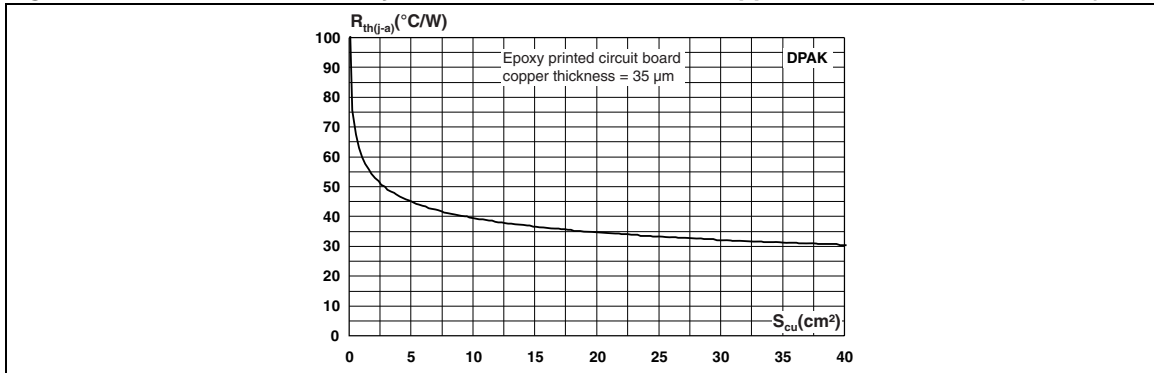


Figure 11. Thermal resistance junction to ambient versus copper surface under tab (DPAK)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 12. TO-220AB dimensions

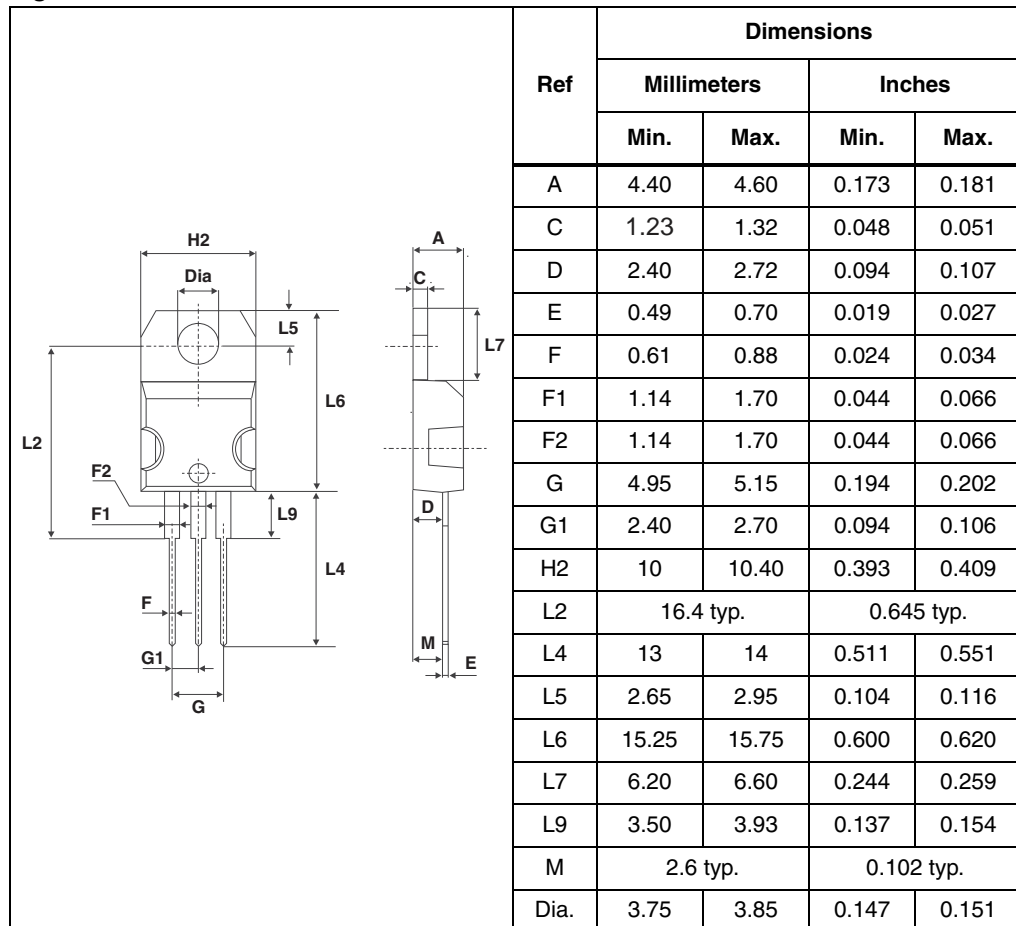
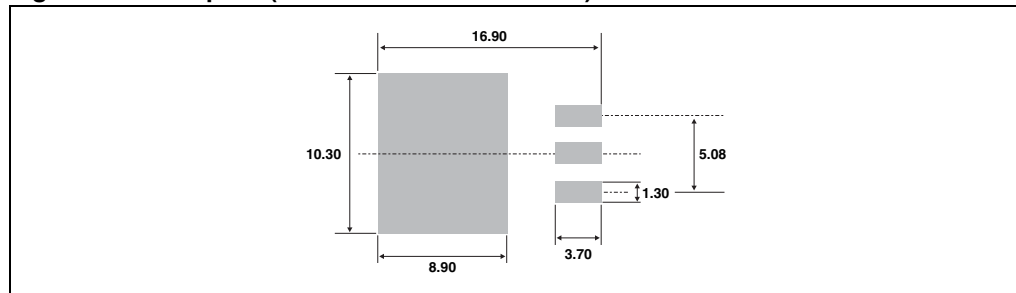


Table 5. D²PAK dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
A1	2.49	2.69	0.098	0.106
A2	0.03	0.23	0.001	0.009
B	0.70	0.93	0.027	0.037
B2	1.14	1.70	0.045	0.067
C	0.45	0.60	0.017	0.024
C2	1.23	1.36	0.048	0.054
D	8.95	9.35	0.352	0.368
E	10.00	10.40	0.393	0.409
G	4.88	5.28	0.192	0.208
L	15.00	15.85	0.590	0.624
L2	1.27	1.40	0.050	0.055
L3	1.40	1.75	0.055	0.069
M	2.40	3.20	0.094	0.126
R	0.40 typ.		0.016 typ.	
V2	0°	8°	0°	8°

Figure 13. Footprint (dimensions in millimeters)



Mounting (soldering) the I²PAK metal slug (heatsink) with alloy, like a surface mount device, IS NOT PERMITTED. A standard through-hole mounting is mandatory.

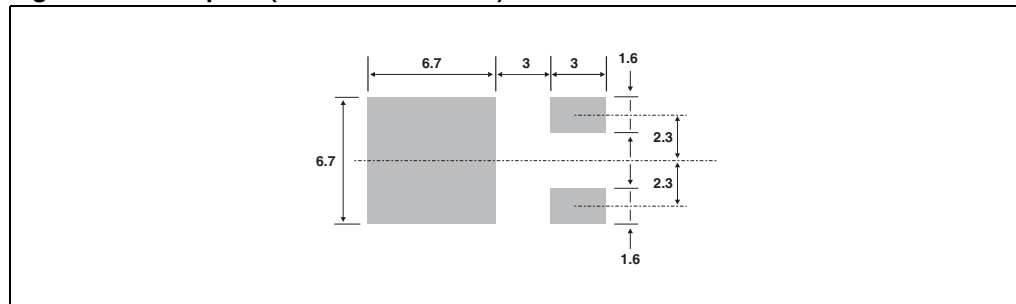
Figure 14. I²PAK dimensions

Ref	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40	4.60	0.173	0.181	A	4.40
A1	2.49	2.69	0.098	0.106	A1	2.49
b	0.70	0.93	0.028	0.037	b	0.70
b1	1.14	1.17	0.044	0.046	b1	1.14
b2	1.14	1.17	0.044	0.046	b2	1.14
c	0.45	0.60	0.018	0.024	c	0.45
c2	1.23	1.36	0.048	0.054	c2	1.23
D	8.95	9.35	0.352	0.368	D	8.95
e	2.40	2.70	0.094	0.106	e	2.40
E	10.0	10.4	0.394	0.409	E	10.0
L	13.1	13.6	0.516	0.535	L	13.1
L1	3.48	3.78	0.137	0.149	L1	3.48
L2	1.27	1.40	0.050	0.055	L2	1.27

Table 6. DPAK dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.20	2.40	0.086	0.094
A1	0.90	1.10	0.035	0.043
A2	0.03	0.23	0.001	0.009
B	0.64	0.90	0.025	0.035
B2	5.20	5.40	0.204	0.212
C	0.45	0.60	0.017	0.023
C2	0.48	0.60	0.018	0.023
D	6.00	6.20	0.236	0.244
E	6.40	6.60	0.251	0.259
G	4.40	4.60	0.173	0.181
H	9.35	10.10	0.368	0.397
L2	0.80 typ.		0.031 typ.	
L4	0.60	1.00	0.023	0.039
V2	0°	8°	0°	8°

Figure 15. Footprint (dimensions in mm)



3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS1545CT	STPS1545CT	TO-220AB	2.23 g	50	Tube
STPS1545CG	STPS1545CG	D ² PAK	1.48 g	50	Tube
STPS1545CG-TR	STPS1545CG	D ² PAK	1.48 g	1000	Tape and reel
STPS1545CR	STPS1545CR	I ² PAK	1.49 g	50	Tube
STPS1545CB-TR	STPS1545CB	DPAK	0.3 g	2500	Tape and reel

For the latest information on available order codes see the product pages on www.st.com.

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
Jul-2003	5F	Last release.
21-Mar-2007	6	Removed ISOWATT and TO-220FPAB packages.
03-Nov-2010	7	Added DPAK package.

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